

3.0x2.5mm SURFACE MOUNT LED LAMP

Part Number: APB3025ESGC-F01

High Efficiency Red Super Bright Green

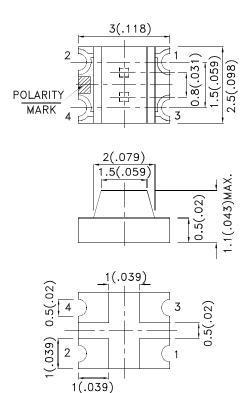
Features

- 3.0mmx2.5mm SMT LED, 1.1mm thickness.
- Bi -color,low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Descriptions

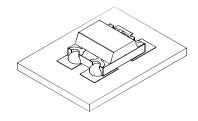
- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.
- The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions





GREEN



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAE4850 **REV NO: V.13A** DATE: JAN/08/2014 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: L.Q.Xie



PAGE: 1 OF 6 ERP: 1203000696

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APB3025ESGC-F01	High Efficiency Red (GaAsP/GaP)	Water Clear	8	15	120°
			*3	*8	
	Super Bright Green (GaP)		8	15	
			*8	*15	

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red Super Bright Green	627 565		nm	I==20mA
λD [1]	Dominant Wavelength	High Efficiency Red Super Bright Green	617 568		nm	I==20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red Super Bright Green	45 30		nm	I==20mA
С	Capacitance	High Efficiency Red Super Bright Green	15 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	High Efficiency Red Super Bright Green	2 2.2	2.5 2.5	V	I==20mA
lR	Reverse Current	High Efficiency Red Super Bright Green		10 10	uA	V _R = 5V

Notes:

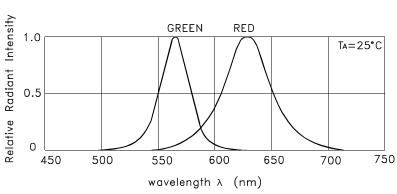
- 1.Wavelength: +/-1nm.
- 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	High Efficiency Red	Super Bright Green	Units		
Power dissipation	75	62.5	mW		
DC Forward Current	30	25	mA		
Peak Forward Current [1]	160	140	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

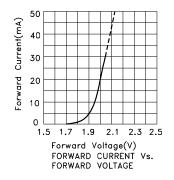
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

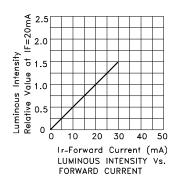
SPEC NO: DSAE4850 **REV NO: V.13A** DATE: JAN/08/2014 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: L.Q.Xie ERP: 1203000696

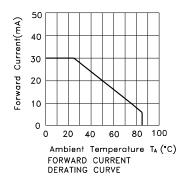


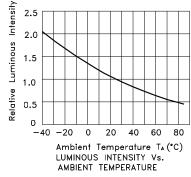
RELATIVE INTENSITY Vs. WAVELENGTH

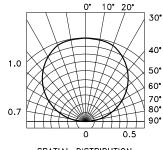
APB3025ESGC-F01 High Efficiency Red







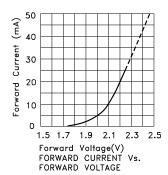


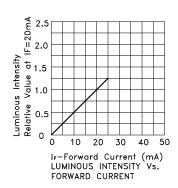


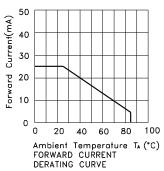
SPATIAL DISTRIBUTION

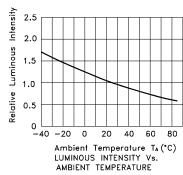
SPEC NO: DSAE4850 REV NO: V.13A DATE: JAN/08/2014 PAGE: 3 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: L.Q.Xie ERP: 1203000696

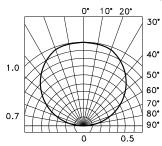
Super Bright Green











SPATIAL DISTRIBUTION

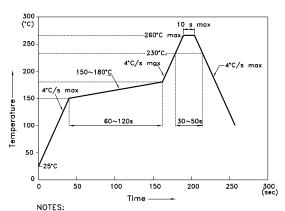
 SPEC NO: DSAE4850
 REV NO: V.13A
 DATE: JAN/08/2014
 PAGE: 4 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: L.Q.Xie
 ERP: 1203000696

APB3025ESGC-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



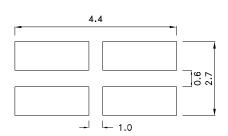
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

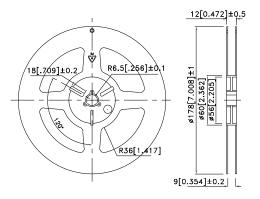
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

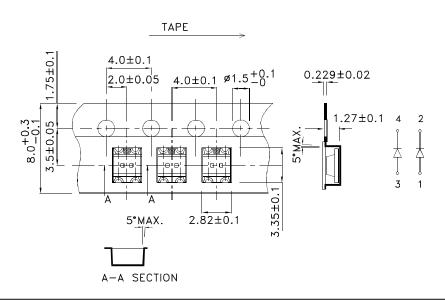
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units: mm)



SPEC NO: DSAE4850 **APPROVED: WYNEC**

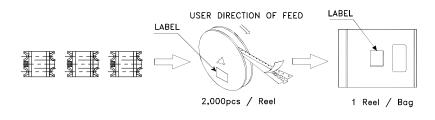
REV NO: V.13A CHECKED: Allen Liu

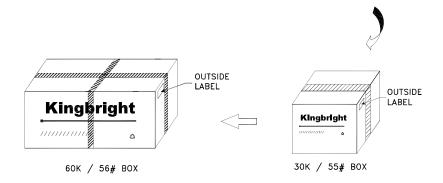
DATE: JAN/08/2014 DRAWN: L.Q.Xie

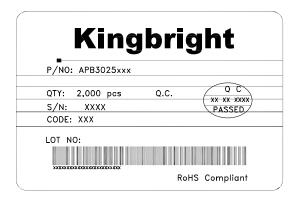
PAGE: 5 OF 6 ERP: 1203000696

PACKING & LABEL SPECIFICATIONS

APB3025ESGC-F01







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2.The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6.All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

SPEC NO: DSAE4850 REV NO: V.13A DATE: JAN/08/2014 PAGE: 6 OF 6

APPROVED: WYNEC CHECKED: Allen Liu DRAWN: L.Q.Xie ERP: 1203000696